

Initial Product/Process Change Notification

Document #:IPCN21292XM Issue Date: 26 Aug 2022

Title of Change:	Qualification of VHVIC	Qualification of VHVIC (Very High Voltage IC) Technology at onsemi Aizu Japan - Phase 3.		
Proposed First Ship date:	14 Jan 2023 or earlier i	14 Jan 2023 or earlier if approved by customer		
Contact Information:	Contact your local onse	Contact your local onsemi Sales Office or <u>Scott.Brow@onsemi.com</u>		
PCN Samples Contact:	Sample requests are to Initial PCN or Final PCN Samples delivery timin	Contact your local onsemi Sales Office. Sample requests are to be submitted no later than 30 days from the date of first notification, Initial PCN or Final PCN, for this change. Samples delivery timing will be subject to request date, sample quantity and special customer packing/label requirements.		
Type of Notification:	advance notification ab change details and dev The completed quali Product/Process Chang Product/Process Chang	This is an Initial Product/Process Change Notification (IPCN) sent to customers. An IPCN is an advance notification about an upcoming change and contains general information regarding the change details and devices affected. It also contains the preliminary reliability qualification plan. The completed qualification and characterization data will be included in the Final Product/Process Change Notification (FPCN). This IPCN notification will be followed by a Final Product/Process Change Notification (FPCN) at least 90 days prior to implementation of the change. In case of questions, contact <pcn.support@onsemi.com></pcn.support@onsemi.com>		
Marking of Parts/ Traceability of Change:		e by trace codes and lot numbers associated with the product. bine product from (2) different wafer FABs on the same reel of product.		
Change Category:	Wafer Fab Change			
Change Sub-Category(s):	Manufacturing Site Add	dition		
Sites Affected:	•			
onsemi Sites		External Foundry/Subcon Sites		
onsemi Aizu, Japan		None		
		l.		

Description and Purpose:

onsemi would like to notify its customers of the qualification of our Very High Voltage IC (VHVIC) Technology at our onsemi Aizu, Japan FAB.

This qualification enables expanded capacity for this technology.

All products listed in this IPCN may be dual sourced from either the current onsemi wafer FAB in Gresham, OR US or onsemi Aizu, Japan.

This is the latest PCN associated with this change.

This technology was previously qualified into Aizu and has been running at these FAB for > 5 years for other products in this technology.

Reference FPCN21292X-FPCN21292XL for previous notifications on this equivalent change.

Before Change Description		After Change Description	
FAB onsemi Gresham, USA		onsemi Aizu, Japan	onsemi Gresham, USA

There are no product material changes as a result of this change.

There is no product marking change as a result of this change.

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Issue Date: 25 Aug 2022

Qualification Plan:

QV DEVICE NAME: NCP1236BD65R2G

PACKAGE: SOIC 8 (Less Pin 7) **RMS#**: P31397, O30920

Test	Specification	Condition	Interval	Results
HTOL	JESD22-A108	Ta=125°C, 500V	1000 hrs	0/231
HTSL	JESD22-A103	Ta= 150°C	1000 hrs	0/231
PC-TC	JESD22-A104	Ta= -65°C to +150°C	500 сус	0/231
HAST	JESD22-A110	130°C, 85% RH, 18.8psig, bias	96 hrs	0/231
PC-uHAST	JESD22-A118	130°C, 85% RH, 18.8psig, unbiased	96 hrs	0/231
PC	J-STD-020 JESD-A113	MSL 1 @ 260 °C		0/693

QV DEVICE NAME: NCP1396ADR2G

PACKAGE: SOIC-16

RMS#: P31418, O36903, O37701

Test	Specification	Condition	Interval	Results
HTOL	JESD22-A108	Ta=125°C, 600V	1000 hrs	0/231
HTSL	JESD22-A103	Ta= 150°C	1000 hrs	0/231
PC-TC	JESD22-A104	Ta= -65°C to +150°C	500 сус	0/231
HAST	JESD22-A110	130°C, 85% RH, 18.8psig, bias	96 hrs	0/231
PC- uHAST	JESD22-A118	130°C, 85% RH, 18.8psig, unbiased	96 hrs	0/231
PC	J-STD-020 JESD-A113	MSL 1 @ 260 °C		0/693

QV DEVICE NAME: NCP1399AADR2G

PACKAGE: SOIC-16 RMS#: P31421

Test	Specification	Condition	Interval	Results
HTOL	JESD22-A108	Ta=125°C, 600V	1000 hrs	0/77

QV DEVICE NAME: NCP1615C3DR2G PACKAGE: SOIC-16 (Less Pin 15)

RMS#: P31422

Test	Specification	Condition	Interval	Results
HTOL	JESD22-A108	Ta=125°C, 700V	1000 hrs	0/77

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QV DEVICE NAME: NCP1380BDR2G

PACKAGE: SOIC-8 RMS#: O32111

Test	Specification	Condition	Interval	Results
HTOL	JESD22-A108	Ta=125°C, 30V	1000 hrs	0/77

QV DEVICE NAME: NCP4304ADR2G

PACKAGE: SOIC-8 RMS#: P31423, O35972

Test	Specification	Condition	Interval	Results
HTOL	JESD22-A108	Ta=125°C, 200V	1000 hrs	0/231
HTSL	JESD22-A103	Ta= 150°C	1000 hrs	0/231
PC-TC	JESD22-A104	Ta= -65°C to +150°C	500 cyc	0/231
HAST	JESD22-A110	130°C, 85% RH, 18.8psig, bias	96 hrs	0/231
PC-uHAST	JESD22-A118	130°C, 85% RH, 18.8psig, unbiased	96 hrs	0/231
PC	J-STD-020 JESD-A113	MSL 1 @ 260 °C		0/693

QV DEVICE NAME: NCP1076P065G **PACKAGE:** PDIP-8 (Less Pin 7) **RMS#:** P39367, O39368

Test	Specification	Condition	Interval	Results
HTOL	JESD22-A108	Ta=125°C, 200V	1000 hrs	0/240
HTSL	JESD22-A103	Ta= 150°C	1000 hrs	0/240
TC	JESD22-A104	Ta= -65°C to +150°C	500 cyc	0/240
HAST	JESD22-A110	130°C, 85% RH, 18.8psig, bias	96 hrs	0/240
uHAST	JESD22-A118	130°C, 85% RH, 18.8psig, unbiased	96 hrs	0/240

List of Affected Parts:

Note: Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the <u>PCN Customized Portal</u>.

Part Number	Qualification Vehicle
NCP1034DR2G	NCP1396ADR2G
NCP1606ADR2G	NCP1236BD65R2G, NCP1380BDR2G
NCP1606BDR2G	NCP1236BD65R2G, NCP1380BDR2G
NCP5106ADR2G	NCP1396ADR2G
NCP5106BDR2G	NCP1396ADR2G
NCP5109ADR2G	NCP1396ADR2G

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NCP5109BDR2G	NCP1396ADR2G	
NCP5111DR2G	NCP1396ADR2G	
NCP5304DR2G	NCP1396ADR2G	
NCL30001DR2G	NCP1236BD65R2G, NCP1380BDR2G	
NCP1562ADR2G	NCP1236BD65R2G	
NCP1562BDR2G	NCP1236BD65R2G	
NCP5104DR2G	NCP1396ADR2G	
NCL30059BDR2G	NCP1396ADR2G	
NCP1392BDR2G	NCP1396ADR2G	
NCP1392DDR2G	NCP1396ADR2G	
NCP1393BDR2G	NCP1396ADR2G	
NCP4303ADR2G	NCP4304ADR2G	
NCP1910B65DWR2G	NCP1396ADR2G	
NCP1236DD65R2G	NCP1236BD65R2G	
NCP1937A2DR2G	NCP1399AADR2G	
NCP1937A3DR2G	NCP1399AADR2G	
NCP1937B1DR2G	NCP1399AADR2G	
NCP1937B3DR2G	NCP1399AADR2G	
NCP1937B51DR2G	NCP1399AADR2G	
NCP1937C4DR2G	NCP1399AADR2G	
NCP1937C61DR2G	NCP1399AADR2G	
NCP1632ADR2G	NCP1236BD65R2G, NCP1380BDR2G	
NCP1632DR2G	NCP1236BD65R2G, NCP1380BDR2G	
NCP5183DR2G	NCP1396ADR2G	
NCP1240AD100R2G	NCP1236BD65R2G	
NCL30030B3DR2G	NCP1236BD65R2G, NCP1399AADR2G	
NCP1071STBT3G	NCP1076P065G	
NCP1339HDR2G	NCP1399AADR2G	
NCP1616A2DR2G	NCP1615C3DR2G	
NCP1616A1DR2G	NCP1615C3DR2G	
NCL30060BDR2G	NCP1399AADR2G	
NCL30060B2DR2G	NCP1399AADR2G	
NCP1562ADBR2G	NCP1236BD65R2G	

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